

PMT21EN,115 Datasheet

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DiGi Electronics Part Number
Manufacturer
Manufacturer Product Number
Description
Detailed Description

PMT21EN,115-DG Nexperia USA Inc. PMT21EN,115 MOSFET N-CH 30V 7.4A SOT223

N-Channel 30 V 7.4A (Ta) 820mW (Ta), 8.33W (Tc) S urface Mount SOT-223

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Purchase and inquiry

Manufacturer Product Number:	Manufacturer:
PMT21EN,115	Nexperia USA Inc.
Series:	Product Status:
	Obsolete
FET Type:	Technology:
N-Channel	MOSFET (Metal Oxide)
Drain to Source Voltage (Vdss):	Current - Continuous Drain (ld) @ 25°C:
30 V	7.4A (Ta)
Drive Voltage (Max Rds On, Min Rds On):	Rds On (Max) @ ld, Vgs:
4.5V, 10V	21mOhm @ 7.4A, 10V
Vgs(th) (Max) @ ld:	Gate Charge (Qg) (Max) @ Vgs:
2.5V @ 250µA	14.4 nC @ 10 V
Vgs (Max):	Input Capacitance (Ciss) (Max) @ Vds:
±20V	588 pF @ 15 V
FET Feature:	Power Dissipation (Max):
	820mW (Ta), 8.33W (Tc)
Operating Temperature:	Mounting Type:
-55°C ~ 150°C (TJ)	Surface Mount
Supplier Device Package:	Package / Case:
SOT-223	TO-261-4, TO-261AA

Environmental & Export classification

RoHS Status:	Moisture Sensitivity Level (MSL):
ROHS3 Compliant	1 (Unlimited)
REACH Status:	ECCN:
REACH Unaffected	EAR99
HTSUS:	
8541.29.0095	



PMT21EN 30 V, 7.4 A N-channel Trench MOSFET Rev. 1 – 30 August 2011

Product data sheet

1. Product profile

1.1 General description

N-channel enhancement mode Field-Effect Transistor (FET) in a small SOT223 (SC-73) small Surface-Mounted Device (SMD) plastic package using Trench MOSFET technology.

1.2 Features and benefits

- Logic-level compatible
- Very fast switching

1.3 Applications

- Relay driver
- High-speed line driver

- Trench MOSFET technology
- Low-side loadswitch
- Switching circuits

1.4 Quick reference data

Table 1.	Quick reference data						
Symbol	Parameter	Conditions		Min	Тур	Max	Unit
V _{DS}	drain-source voltage	T _j = 25 °C		-	-	30	V
V _{GS}	gate-source voltage			-20	-	20	V
I _D	drain current	V_{GS} = 10 V; T_{amb} = 25 °C	<u>[1]</u>	-	-	7.4	А
Static cha	aracteristics						
R_{DSon}	drain-source on-state resistance	V_{GS} = 10 V; I_D = 7.4 A; T_j = 25 °C		-	18	21	mΩ

[1] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated, mounting pad for drain 6 cm².

2. Pinning information

Table 2.	Pinning	j information		
Pin	Symbol	Description	Simplified outline	Graphic symbol
1	G	gate		5
2	D	drain		
3	S	source		
4	D	drain		Ű – Č
			⊟1 ⊟2 ⊟3 SOT223 (SC-73)	S 017aaa253
			301223 (30-73)	017888255



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3. Ordering information

Table 3. Orderin	g information		
Type number	Package		
	Name	Description	Version
PMT21EN	SC-73	plastic surface-mounted package with increased heatsink; 4 leads	SOT223

4. Marking

Table 4. Marking	J codes
Type number	Marking code
PMT21EN	MT21EN

5. Limiting values

Table 5.Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

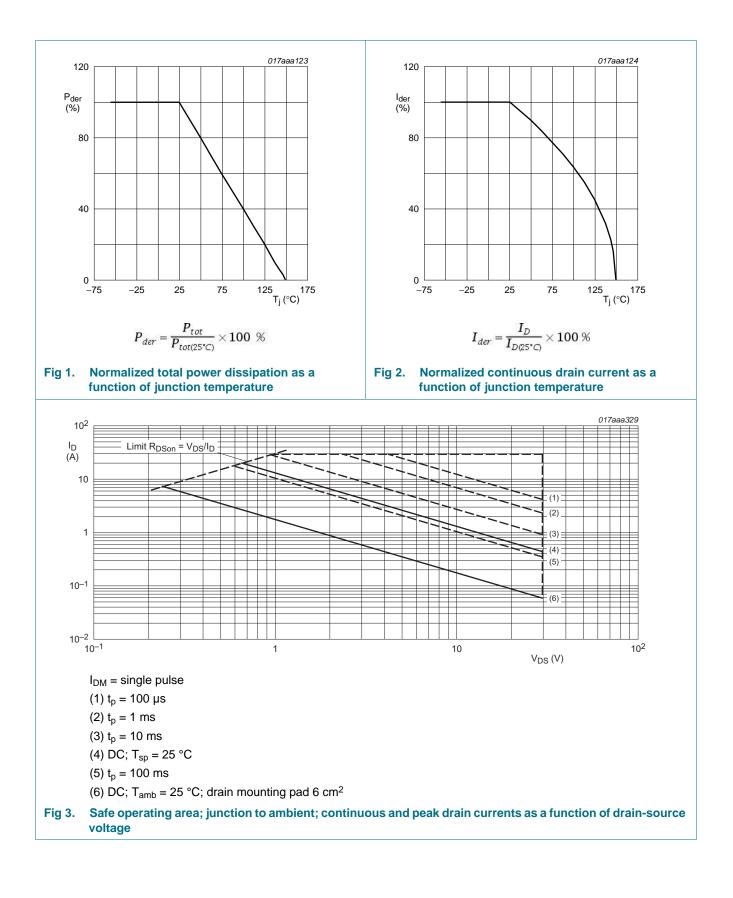
Symbol	Parameter	Conditions		Min	Max	Unit
V _{DS}	drain-source voltage	$T_j = 25 \ ^{\circ}C$	T _j = 25 °C		30	V
V _{GS}	gate-source voltage			-20	20	V
I _D	drain current0	V_{GS} = 10 V; T_{amb} = 25 °C	<u>[1]</u>	-	7.4	А
		V_{GS} = 10 V; T_{amb} = 100 °C	<u>[1]</u>	-	4.7	А
I _{DM}	peak drain current	$T_{amb} = 25 \text{ °C}$; single pulse; $t_p \le 10 \mu\text{s}$		-	30	А
P _{tot} total power dissipation	total power dissipation	T _{amb} = 25 °C	[2]	-	820	mW
			[1]	-	1760	mW
		T _{sp} = 25 °C		-	8330	mW
Tj	junction temperature			-55	150	°C
T _{amb}	ambient temperature			-55	150	°C
T _{stg}	storage temperature			-65	150	°C
Source-dra	in diode					
Is	source current	T _{amb} = 25 °C	[1]	-	1.9	А

[1] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated, mounting pad for drain 6 cm².

[2] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated and standard footprint.

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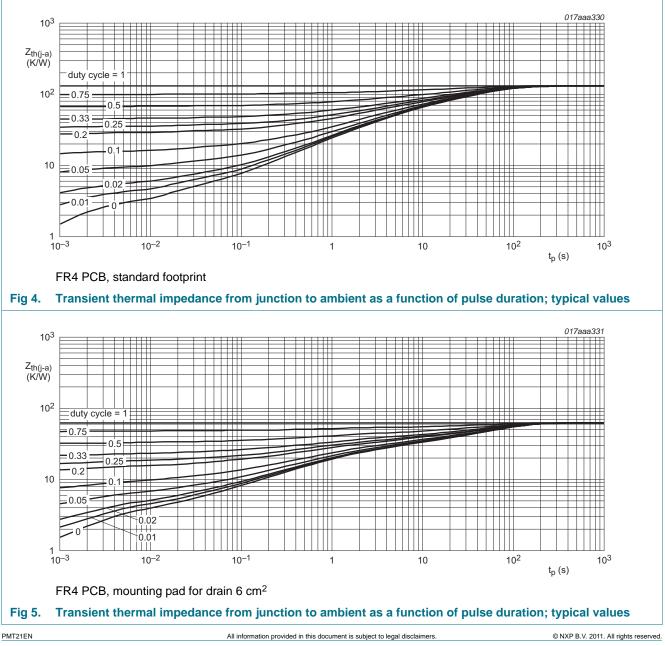
30 V, 7.4 A N-channel Trench MOSFET

6. Thermal characteristics

Table 6.	Thermal characteristics						
Symbol	Parameter	Conditions		Min	Тур	Max	Unit
R _{th(j-a)}	thermal resistance	in free air	<u>[1]</u>	-	132	152	K/W
	from junction to ambient	[2]	[2]	-	62	71	K/W
R _{th(j-sp)}	thermal resistance from junction to solder point			-	8	15	K/W

[1] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.

[2] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for drain 6 cm².



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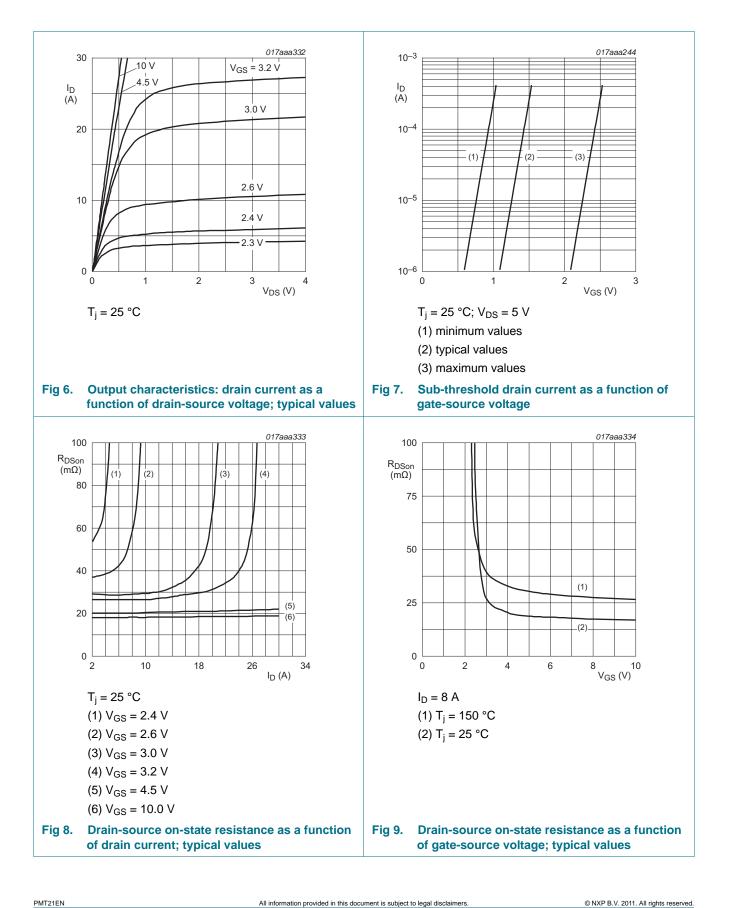
30 V, 7.4 A N-channel Trench MOSFET

7. Characteristics

Table 7.	Characteristics					
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Static cha	aracteristics					
V _{(BR)DSS}	drain-source breakdown voltage	$I_D = 250 \ \mu\text{A}; \ V_{GS} = 0 \ V; \ T_j = 25 \ ^\circ\text{C}$	30	-	-	V
V _{GSth}	gate-source threshold voltage	$I_D = 250 \ \mu A; \ V_{DS} = V_{GS}; \ T_j = 25 \ ^{\circ}C$	1	1.5	2.5	V
I _{DSS}	drain leakage current	$V_{DS} = 30 \text{ V}; V_{GS} = 0 \text{ V}; T_j = 25 \text{ °C}$	-	-	1	μΑ
		$V_{DS} = 30 \text{ V}; V_{GS} = 0 \text{ V}; T_j = 150 \text{ °C}$	-	-	20	μΑ
I _{GSS}	gate leakage current	$V_{GS} = 20 \text{ V}; V_{DS} = 0 \text{ V}; T_j = 25 \text{ °C}$	-	-	100	nA
		V_{GS} = -20 V; V_{DS} = 0 V; T_j = 25 °C	-	-	100	nA
R _{DSon}	drain-source on-state	V_{GS} = 10 V; I _D = 7.4 A; T _j = 25 °C	-	18	21	mΩ
	resistance	V_{GS} = 10 V; I _D = 7.4 A; T _j = 150 °C	-	27	32	mΩ
		V_{GS} = 4.5 V; I _D = 6.6 A; T _j = 25 °C	-	21	26	mΩ
9 _{fs}	forward transconductance	V_{DS} = 10 V; I _D = 7.4 A; T _j = 25 °C	-	24	-	S
Dynamic	characteristics					
Q _{G(tot)}	total gate charge	V_{DS} = 15 V; I_{D} = 6 A; V_{GS} = 10 V;	-	12.5	14.4	nC
Q _{GS}	gate-source charge	T _j = 25 °C	-	1.7	-	nC
Q_{GD}	gate-drain charge		-	1.8	-	nC
C _{iss}	input capacitance	V_{DS} = 15 V; f = 1 MHz; V_{GS} = 0 V;	-	588	-	pF
C _{oss}	output capacitance	T _j = 25 °C	-	154	-	pF
C _{rss}	reverse transfer capacitance		-	62	-	pF
t _{d(on)}	turn-on delay time	V_{DS} = 15 V; V_{GS} = 10 V; $R_{G(ext)}$ = 6 Ω ;	-	4	-	ns
t _r	rise time	$T_j = 25 \text{ °C}; I_D = 6 \text{ A}$	-	29	-	ns
t _{d(off)}	turn-off delay time		-	172	-	ns
t _f	fall time		-	77	-	ns
Source-d	rain diode					
V _{SD}	source-drain voltage	I _S = 1.92 A; V _{GS} = 0 V; T _i = 25 °C	-	0.7	1.2	V

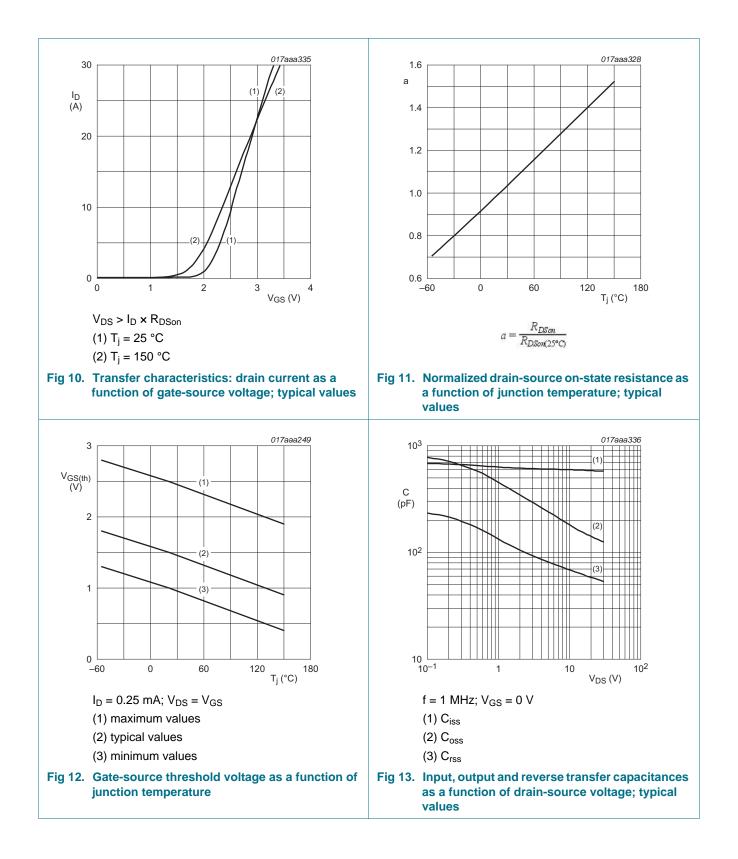
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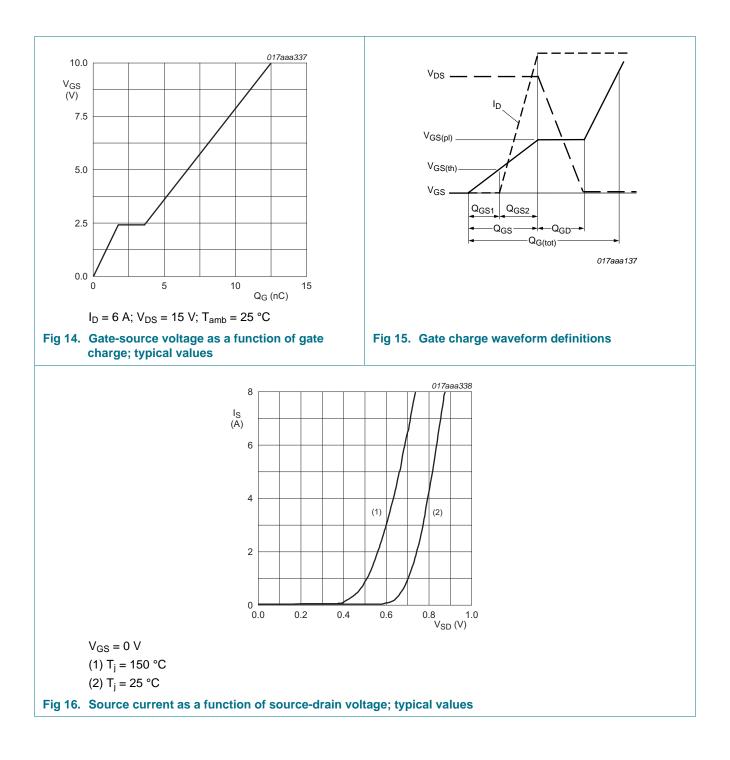


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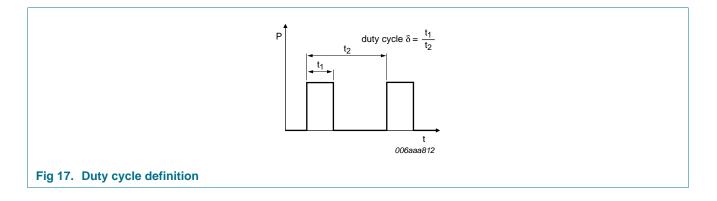


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8. Test information



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9. Package outline

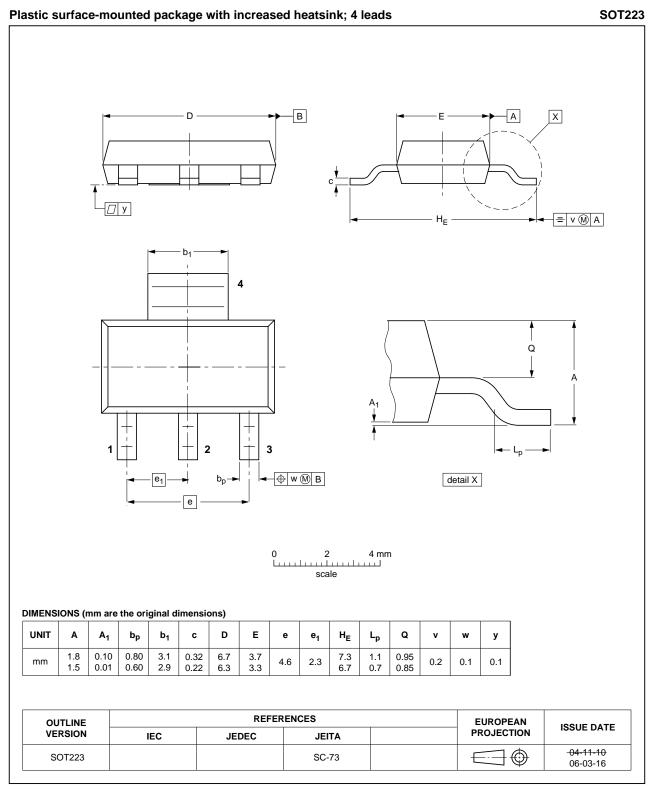


Fig 18. Package outline SOT223 (SC-73)

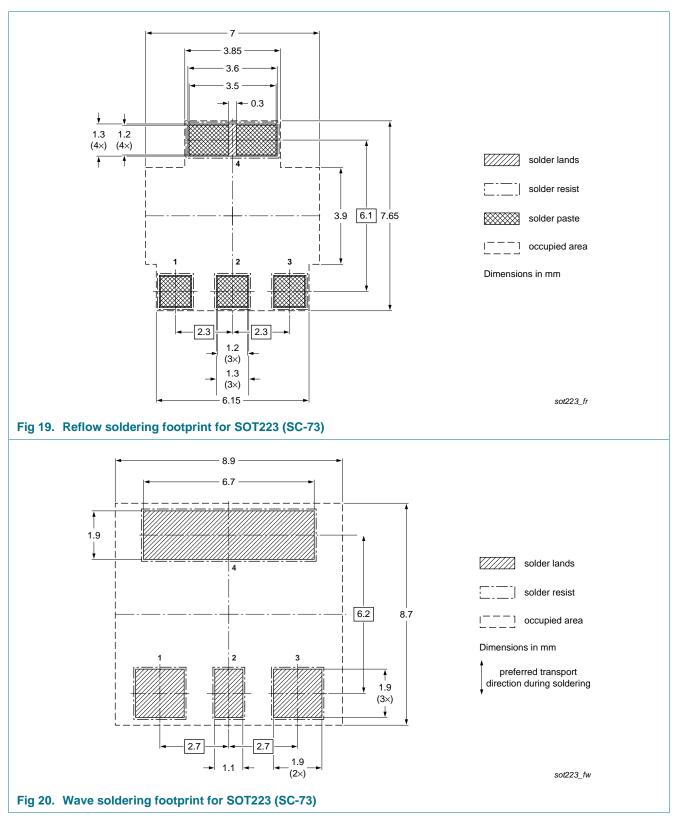
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10. Soldering



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11. Revision history

Table 8.	Revision hi	story			
Document	: ID	Release date	Data sheet status	Change notice	Supersedes
PMT21EN	v.1	20110830	Product data sheet	-	-

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12. Legal information

12.1 Data sheet status

Document status [1] [2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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[2] The term 'short data sheet' is explained in section "Definitions".

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